

Electro-optic phase modulators based on transparent-conducting-oxide loaded silicon waveguides

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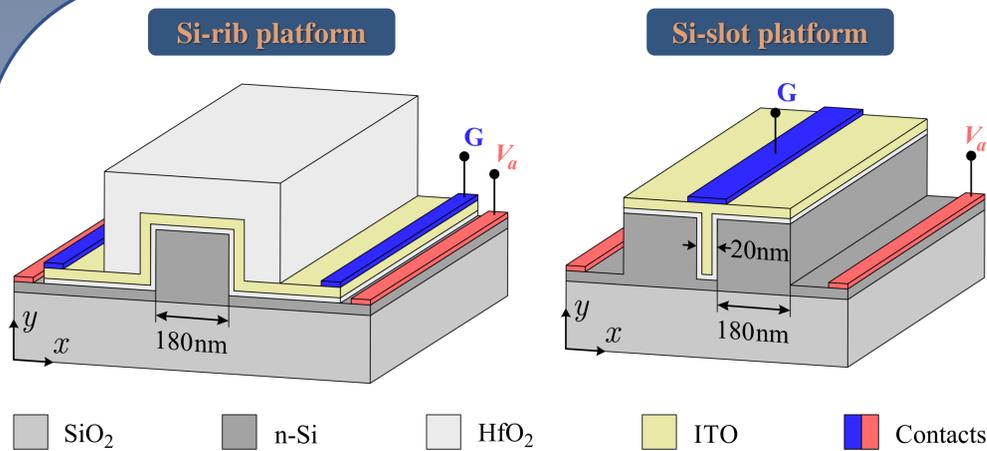
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I Introduction

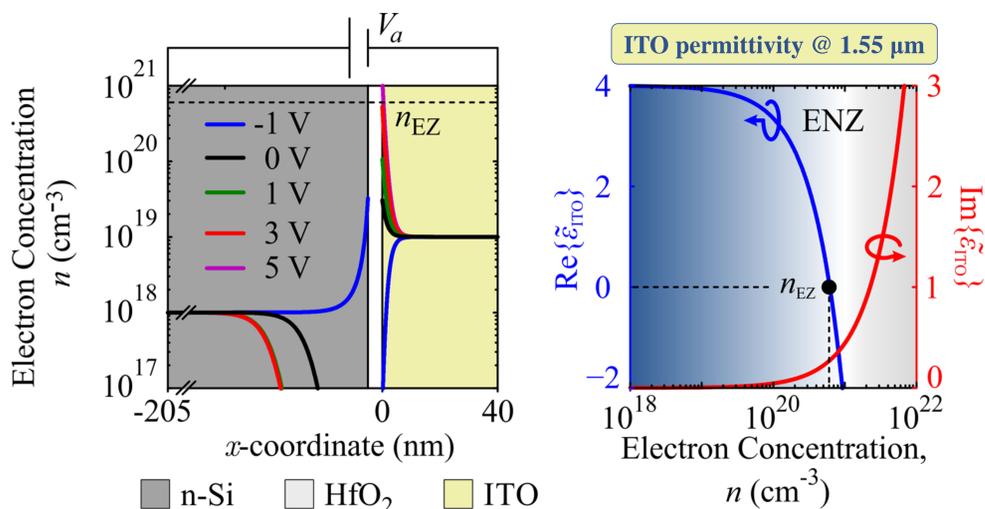
- Objective** → Impress an electrical signal onto the phase of an optical carrier towards realizing **on-chip electro-optical phase-modulation schemes**.
- Motive** → Achieve **more advanced and sophisticated** modulation formats compared to the more frequently employed amplitude modulation solutions.
- Design** → Exploit the **epsilon-near-zero (ENZ) behavior of transparent conducting oxides (TCOs)** in the near-infrared (NIR) [1] along with well-established **silicon-waveguide platforms**.

II Physical platforms



- ❖ In both platforms, the waveguide is conformally coated by two successive layers of **HfO₂ (5 nm) & ITO (10 nm)**, forming a capacitor-like structure for controlling the ITO properties through the **field-effect**.
- **Si-rib platform:** **Weak-waveguiding conditions** are adopted for the fundamental TE-mode in order to enhance the interaction with the superimposed ITO layer. The waveguide is cladded on top by a lossless 200-nm thick HfO₂ layer, aiding waveguiding.
- **Si-slot platform:** **Strong-waveguiding conditions**, enhancing the light-matter interaction in the 20-nm wide slot.

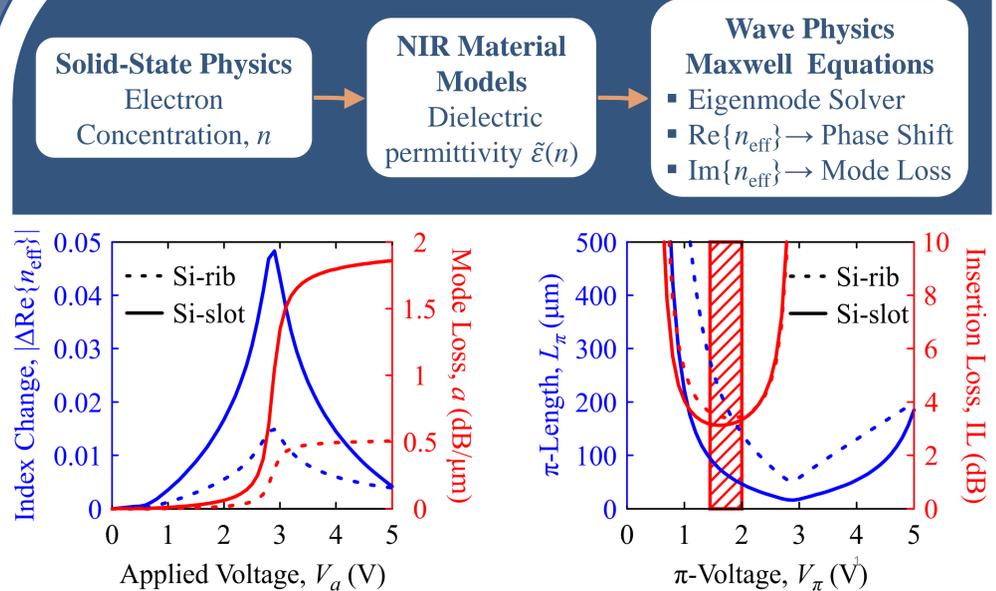
Control Mechanism



- **Field-effect** induced carrier-concentration changes in ITO modulate its NIR permittivity, as described by the **Drude model** [2].
- An initial **10¹⁹ cm⁻³** free-electron concentration is selected for the ITO layer.
- At **n_{EZ} = 6.17 x 10²⁰ cm⁻³**, ITO crosses into the ENZ region for a threshold bias equal to **V_a ~ 3 V**.

III Methods & Results

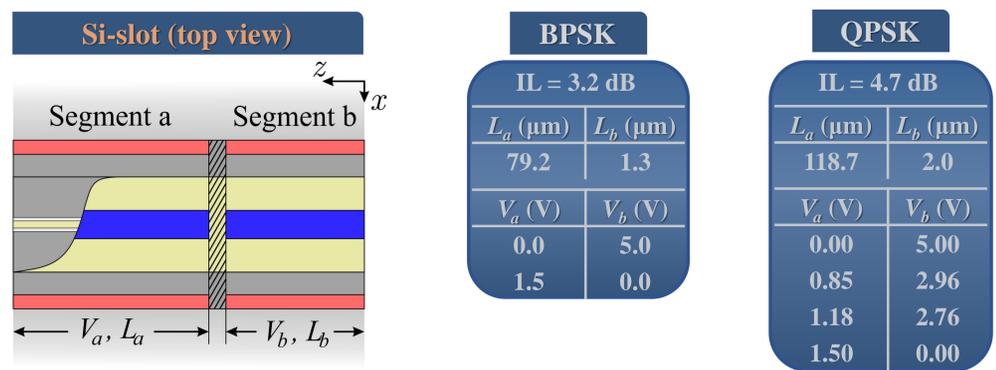
Finite Element Method (FEM) Computational Framework



- **The mode loss maintains high values for V_a > 3 V** due to the ENZ effect → already investigated for amplitude modulation formats [3].
- The change of the effective mode index shows a peak at **V_a ~ 3 V**, where **Re{ε_{ITO}} → 0**.
- **The Si-slot platform achieves enhanced ENZ performance** as a result of the increased light-matter interaction in the slot.
- For both designs, **the total IL** for achieving a π-phase shift obtains its minimum value at **V_a ~ 1.5 V**, calculated **in the order of 3 dB**.
- The **Si-slot platform** demands less than a half length for achieving the π-phase shift, compared to its **Si-rib** counterpart (**76 μm vs 176 μm**).
- Shorter π-lengths can be achieved, reaching a low at **V_a ~ 3 V**, though with a high penalty on the total IL.

BPSK & QPSK Modulation Formats

- A **BPSK modulator** can be directly realized by **equalizing the loss levels of a π-phase shifter**. This is achieved by combining a **couple of independently controlled** waveguide segments in cascade architecture, separated by an electrically insulating and arbitrarily long junction.
- The same design allows for implementing **QPSK modulation formats** as well.



IV Conclusions

SOI-based phase modulators are presented by exploiting free-carrier effects in TCO semiconductors. The proposed designs provide very reduced footprints, **outcompeting their conventional, mm-long, silicon counterparts**[4], experiencing ultra-high switching speeds and a pJ/bit energy consumption [3].

V References

- [1] E. Feigenbaum, et al., Nano Lett., vol. 10, pp. 2111-2116, 2010.
- [2] V. E. Babicheva, et al., Nanophotonics, vol. 4, pp. 165-185, 2015.
- [3] G. Sinatka, et al., J. Appl. Phys., vol. 121, 2017.
- [4] A. Liu, et al., Nature, vol. 427, pp. 615-619, 2004.



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